504630499 11/07/2017

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT4677217

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
NAVID ABEDINI	10/26/2017
CHUN-HAO HSU	10/25/2017
WING IP TAM	10/31/2017
SATHYADEV VENKATA UPPALA	10/26/2017
AMIT MATHUR	10/26/2017

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15708969

CORRESPONDENCE DATA

Fax Number: (713)623-4846

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 713 623 4844

Email: gochoa@pattersonsheridan.com,

psdocketing@pattersonsheridan.com

Correspondent Name: PATTERSON & SHERIDAN, L.L.P. Address Line 1: 24 GREENWAY PLAZA, SUITE 1600

Address Line 4: HOUSTON, TEXAS 77046

ATTORNEY DOCKET NUMBER:	170556US
NAME OF SUBMITTER:	MARCUS W. HAMMACK
SIGNATURE:	/Marcus W. HAMMACK/
DATE SIGNED:	11/07/2017

Total Attachments: 9

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ASSIGNMENT

WHEREAS, WE,

- 1. Navid ABEDINI, a citizen of the Islamic Republic of Iran, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of Raritan, New Jersey.
- 2. Chun-Hao HSU, a citizen of Taiwan, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Jose, California,
- 3. Wing Ip TAM, a citizen of the United States of America, having a mailing address located at I Sulky Lane; Mariboro, NJ 07746 and a resident of Malboro, New Jersey.
- 4. Sathyadev Venkata UPPALA, a citizen of India, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of Whitehouse Station, New Jersey, and
- 5. Amit MATHUR, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of Morganville, New Jersey.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to EARLY DETERMINATION OF AN OPERATION MODE IN A NARROWBAND INTERNET OF THINGS (NB-IOT) SYSTEM (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, or under International Conventions, Treaties, or Agreements, U.S. Application No. 15/708,969, filed September 19, 2017, Qualcomm Reference No. 170556, and all provisional applications relating thereto, and divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals,

reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof.

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Ridge AND On 10-26-17 AND Navid ABEDINI

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	, on		
- 177	LOCATION	DATE	Chun-Hao HSU
Done at	, on		
	LOCATION , on	DATE	Wing Ip TAM
Done a(É	AJJ <u>VidaCavat (C.</u> , on LOCATION	(0-24-)7	U.V. SHL-12-
	LOCATION	DATE	Sathyadev Venkata UPPALA
Done at $\tilde{\gamma}$	A) J <u>Videowick</u> , on Location	10.24.17	
. *	LOČATION	DATE	Amit MATHUR

ASSIGNMENT

WHEREAS, WE,

- 1. Navid ABEDINI, a citizen of the Islamic Republic of Iran, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of Raritan, New Jersey,
- 2. Chun-Hao HSU, a citizen of Taiwan, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of San Jose, California,
- 3. Wing Ip TAM, a citizen of the United States of America, having a mailing address located at 1 Sulky Lane; Marlboro, NJ 07746 and a resident of Malboro, New Jersey,
- 4. Sathyadev Venkata UPPALA, a citizen of India, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of Whitehouse Station, New Jersey, and
- 5. Amit MATHUR, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive; San Diego, California 92121-1714 and a resident of Morganville, New Jersey,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to EARLY DETERMINATION OF AN OPERATION MODE IN A NARROWBAND INTERNET OF THINGS (NB-IOT) SYSTEM (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, or under International Conventions, Treaties, or Agreements, U.S. Application No. 15/708,969, filed September 19, 2017, Qualcomm Reference No. 170556, and all provisional applications relating thereto, and divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals,

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AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		on.			
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	LOCATION		DATE		Navid ABEDINI

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Done at	San Jose	, on $\frac{7\%/3\sqrt{5}777}{\text{DATE}}$	l lede h
	LOCATION	DATE	Chun-Hao HSU
Done at		, on	
	LOCATION	DATE	Wing Ip TAM
Done at		, on	
12000	LOCATION	DATE	Sathyadev Venkata UPPALA
War an and		n'in	
Done at	LOCATION	DATE	Amit MATHUR

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		, on			
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	LOCATION		DATE		Navid ABEDINI

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Done at		, on		
	LOCATION		DATE	Chus-Hao HSU
	I SULKY CAWE,			
Done at	MARLBORD, V.J.	, on	10/31/2017	
	LOCATION	****	DATE	Wing Ip TAM
Venac al		, on		
Done at	LOCATION	, 011	DATE	Sathyadev Venkata UPPALA
Done at		, on		
ranc as	LOCATION	, 0,00	DATE	Amit MATHID

PATENT REEL: 044051 FRAME: 0322

RECORDED: 11/07/2017